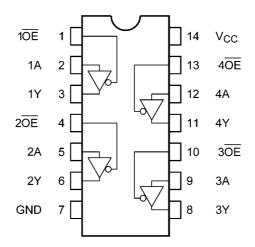
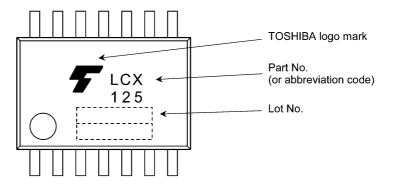
# 5. Pin Assignment

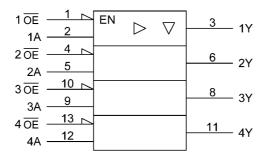
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#### 6. Marking



#### 7. IEC Logic Symbol



### 8. Truth Table

Inputs OE	Inputs A	Outputs Y
Н	Х	Z
L	L	L
L	Н	Н

X: Don't care

Z: High impedance

#### 9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 6.5	V
Input voltage	V <sub>IN</sub>		-0.5 to 6.5	V
Output voltage	V <sub>OUT</sub>	(Note 1)	-0.5 to 6.5	V
		(Note 2)	-0.5 to V <sub>CC</sub> + 0.5	
Input diode current	I <sub>IK</sub>		-50	mA
Output diode current	I <sub>OK</sub>	(Note 3)	±50	mA
Output current	I <sub>OUT</sub>		±50	mA
Power dissipation	PD	(Note 4)	180	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>		±100	mA
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 3:  $V_{OUT}$  < GND,  $V_{OUT}$  >  $V_{CC}$ 

Note 4: 180 mW in the range of  $T_a = -40$  to 85 °C. From  $T_a = 85$  to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

## 10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		1.65 to 3.6	V
		(Note 1)	1.5 to 3.6	
Input voltage	V <sub>IN</sub>		0 to 5.5	V
Output voltage	V <sub>OUT</sub>	(Note 2)	0 to 5.5	V
		(Note 3)	0 to V <sub>CC</sub>	
Output current	I <sub>OH</sub> ,I <sub>OL</sub>	(Note 4)	±24	mA
		(Note 5)	±12	
Operating temperature	T <sub>opr</sub>		-40 to 125	°C
Input rise and fall times	dt/dv	(Note 6)	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 1: Data retention only.

Note 2: Output in OFF state.

Note 3: High or low state

Note 4:  $V_{CC}$  = 3.0 to 3.6 V

Note 5:  $V_{CC}$  = 2.7 to 3.0 V

Note 6:  $V_{\text{IN}}$  = 0.8 to 2.0 V ,  $V_{\text{CC}}$  = 3.0 V

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## **11. Electrical Characteristics**

# 11.1. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 2.3	$V_{CC}  imes 0.9$	—	V
				2.3 to 2.7	1.7	_	
				2.7 to 3.6	2.0	_	
Low-level input voltage	V <sub>IL</sub>	—		1.65 to 2.3	_	$V_{CC} \times 0.1$	V
				2.3 to 2.7	—	0.7	
				2.7 to 3.6	—	0.8	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	1.65 to 3.6	V <sub>CC</sub> - 0.2	—	V
			I <sub>OH</sub> = -4 mA	1.65	1.05	—	
			I <sub>OH</sub> = -8 mA	2.3	1.7	—	
			I <sub>OH</sub> = -12 mA	2.7	2.2	—	
			I <sub>OH</sub> = -18 mA	3.0	2.4	—	
			I <sub>OH</sub> = -24 mA	3.0	2.2	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.65 to 3.6	—	0.2	V
			I <sub>OL</sub> = 4 mA	1.65	—	0.45	
			I <sub>OL</sub> = 8 mA	2.3	—	0.7	
			I <sub>OL</sub> = 12 mA	2.7	—	0.4	
			I <sub>OL</sub> = 16 mA	3.0	—	0.4	
			I <sub>OL</sub> = 24 mA	3.0	—	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 3.6	—	±5.0	μA
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μA
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0		10.0	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		1.65 to 3.6	_	10.0	μA
		V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	
Quiescent supply current	Δl <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V (per 1 input)		2.7 to 3.6	—	500	μΑ

## 11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C)

Characteristics	Symbol	Test Conditior	1	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	—		1.65 to 2.3	$V_{CC} \times 0.9$	—	V
				2.3 to 2.7	1.7	_	
				2.7 to 3.6	2.0	—	
Low-level input voltage	VIL	—		1.65 to 2.3	_	$V_{CC} \times 0.1$	V
				2.3 to 2.7	—	0.7	
				2.7 to 3.6	_	0.8	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	1.65 to 3.6	V <sub>CC</sub> - 0.2	_	V
			I <sub>OH</sub> = -4 mA	1.65	0.9	_	
			I <sub>OH</sub> = -8 mA	2.3	1.55	—	
			I <sub>OH</sub> = -12 mA	2.7	2.0	—	
			I <sub>OH</sub> = -18 mA	3.0	2.2	_	
			I <sub>OH</sub> = -24 mA	3.0	2.0		
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.65 to 3.6	—	0.2	V
			I <sub>OL</sub> = 4 mA	1.65	—	0.65	
			I <sub>OL</sub> = 8 mA	2.3	—	0.9	
			I <sub>OL</sub> = 12 mA	2.7	—	0.6	
			I <sub>OL</sub> = 16 mA	3.0	—	0.6	
			I <sub>OL</sub> = 24 mA	3.0	—	0.75	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 3.6	—	±20.0	μA
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 5.5 V		1.65 to 3.6	—	±20.0	μA
Power-OFF leakage current	I <sub>OFF</sub>	$V_{IN}/V_{OUT}$ = 5.5 V		0	_	40.0	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		1.65 to 3.6	_	40.0	μA
		$V_{IN}/V_{OUT}$ = 3.6 to 5.5 V		1.65 to 3.6	_	±40.0	
Quiescent supply current	Δl <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V (per 1 input)		2.7 to 3.6	—	5.0	mA

## 11.3. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		See 11.7 AC Test Circuit,	$1.8\pm0.15$	_	20.0	ns
			Table 11.7.1, Fig. 11.8.1, Table 11.8.1	$2.5\pm0.2$	_	7.5	
				2.7	_	6.5	
				$3.3\pm0.3$	1.5	6.0	
3-state output enable time	nable time t <sub>PZL</sub> ,t <sub>PZH</sub>		See 11.7 AC Test Circuit,	$1.8\pm0.15$	_	30.0	ns
			Table 11.7.1, Fig. 11.8.2, Table 11.8.1	$2.5\pm0.2$	_	15.0	
				2.7	_	8.0	
				$3.3\pm0.3$	1.5	7.0	
3-state output disable time	t <sub>PLZ</sub> ,t <sub>PHZ</sub>		See 11.7 AC Test Circuit, Table 11.7.1, Fig. 11.8.2, Table 11.8.1	$1.8\pm0.15$	_	28.0	ns
				$2.5\pm0.2$	_	14.0	
				2.7	_	7.0	
				$3.3\pm0.3$	1.5	6.0	
Output skew	t <sub>osLH</sub> ,t <sub>osHL</sub>	(Note 1)	_	2.7	_	—	ns
				$3.3\pm0.3$	_	1.0	

Note 1: Parameter guaranteed by design. ( $t_{osLH} = |t_{PLH}m-t_{PLH}n|$ ,  $t_{osHL} = |t_{PHL}m-t_{PHL}n|$ )

## 11.4. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		See 11.7 AC Test Circuit,	$1.8\pm0.15$	_	22.0	ns
			Table 11.7.1, Fig. 11.8.1, Table 11.8.1	$2.5\pm0.2$	_	8.5	
			Fig. 11.0.1, Table 11.0.1	2.7	_	7.5	
				$3.3\pm0.3$	1.5	7.0	
3-state output enable time	e output enable time t <sub>PZL</sub> ,t <sub>PZH</sub>		See 11.7 AC Test Circuit,	$1.8\pm0.15$	_	33.0	ns
			Table 11.7.1, Fig. 11.8.2, Table 11.8.1	$2.5\pm0.2$	_	16.5	
				2.7	_	9.0	
				$3.3\pm0.3$	1.5	8.0	
3-state output disable time	t <sub>PLZ</sub> ,t <sub>PHZ</sub>		See 11.7 AC Test Circuit, Table 11.7.1, Fig. 11.8.2, Table 11.8.1	1.8 ± 0.15	_	31.0	ns
				$2.5\pm0.2$	_	15.5	
				2.7	_	8.0	
				$3.3\pm0.3$	1.5	7.0	
Output skew	t <sub>osLH</sub> ,t <sub>osHL</sub>	(Note 1)	—	2.7	_	_	ns
				$3.3\pm0.3$	_	1.0	

Note 1: Parameter guaranteed by design. ( $t_{osLH} = |t_{PLH}m-t_{PLH}n|$ ,  $t_{osHL} = |t_{PHL}m-t_{PHL}n|$ )

# 11.5. Dynamic Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic $V_{\text{OL}}$	V <sub>OLP</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V
Quiet output minimum dynamic $V_{OL}$	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

### 11.6. Capacitive Characteristics (Unless otherwise specified, Ta = 25 °C)

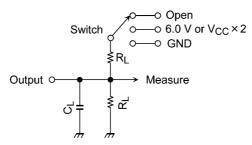
Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>			3.3	7	pF
Output capacitance	C <sub>OUT</sub>			3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	f <sub>IN</sub> = 10 MHz	3.3	25	pF

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC}(opr) = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4 \text{ (per 1 gate)}$ 

## 11.7. AC Test Circuit

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Parameter	Switch	Test Condition
t <sub>PLH</sub> , t <sub>PHL</sub>	OPEN	—
t <sub>PLZ</sub> , t <sub>PZL</sub>	6.0 V	$V_{CC}$ = 3.3 $\pm$ 0.3 V
		V <sub>CC</sub> = 2.7 V
	$V_{CC} \times 2$	$V_{CC}$ = 2.5 $\pm$ 0.2 V
		$V_{CC}$ = 1.8 $\pm$ 0.15 V
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND	—

Table 11.7.1	Parameter for AC	<b>Test Circuit</b>
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## 11.8. AC Waveform

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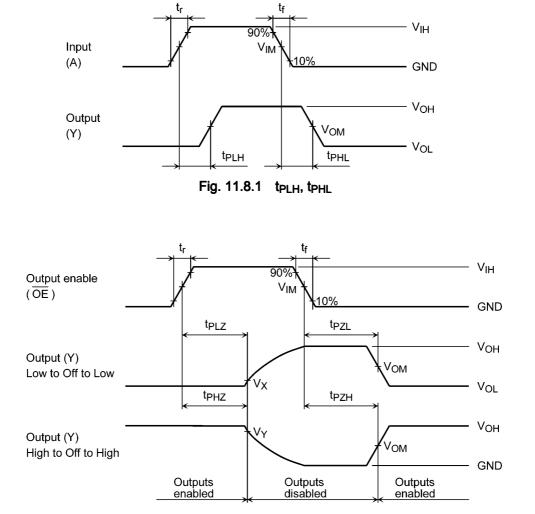


Fig. 11.8.2 tplz, tpHz, tpzL, tpzH

Table 11.8.1	AC Waveform Symbols
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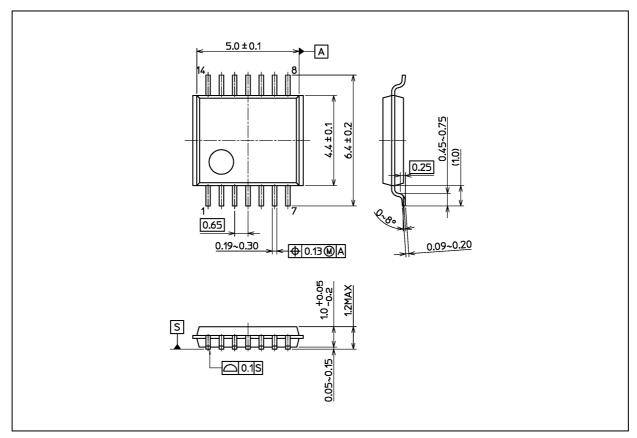
	Symbol	$V_{CC}$ = 3.3 ± 0.3 V $V_{CC}$ = 2.7 V	$V_{CC}$ = 2.5 $\pm$ 0.2 V	$V_{CC}$ = 1.8 $\pm$ 0.15 V
Input	V <sub>IH</sub>	2.7 V	V <sub>CC</sub>	V <sub>CC</sub>
	V <sub>IM</sub>	1.5 V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
	t <sub>r</sub> , t <sub>f</sub>	2.5 ns	2.0 ns	2.0 ns
Output	V <sub>OM</sub>	1.5 V	V <sub>OH</sub> /2	V <sub>OH</sub> /2
	V <sub>X</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V
	V <sub>Y</sub>	V <sub>OH</sub> - 0.3 V	V <sub>OH</sub> - 0.15 V	V <sub>OH</sub> - 0.15 V
Load	CL	50 pF	30 pF	30 pF
	RL	500 Ω	500 Ω	1 kΩ



## 74LCX125FT

## **Package Dimensions**

Unit: mm



Weight: 0.054 g (typ.)

	Package Name(s)		
Nickname: TSSOP14B			

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